

PRIMERGY RX200 S5

System configurator and order-information guide

July 2010

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4x or 6x 2.5" Hot-plug HDD or SSD



8x 2.5" Hot-plug HDD or SDD



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PRIMERGY Server

Instructions

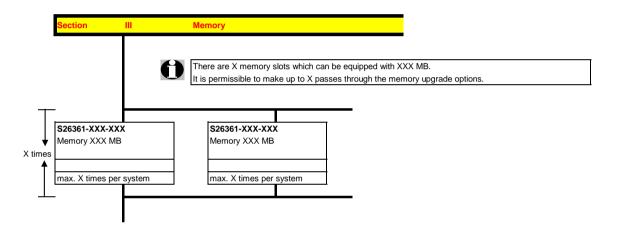
This document contains basic product and configuration information that will enable you to configure your system via PC-/SystemArchitect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



In one chapter you can only select as many components (here 4x) as the arrow indicates.



Please note that there are information symbols which indicate necessary information.



For further information see:

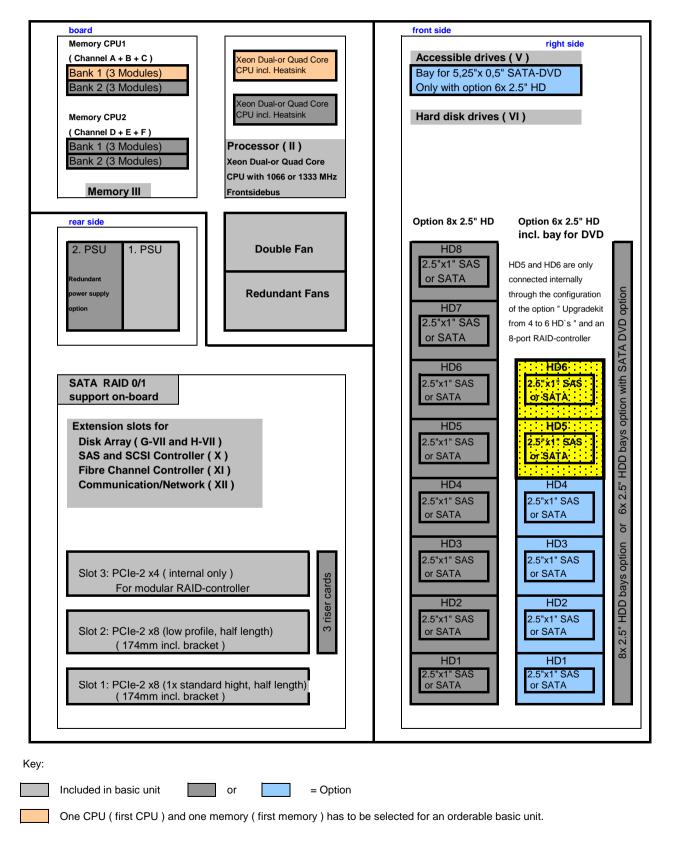
http://ts.fujitsu.com/products/standard_servers/index.html (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy_config/current/Pages/default.aspx (extranet)

Prices and availability see price list and PC-/SystemArchitect. Subject to change and errors excepted.

Configuration diagram PRIMERGY RX200 S5

System unit (I)



HW configurator

Continue with PRIMERGY HW configurator

Start PRIMERGY RX200 S5

Section

Basic unit



System unit consisting of:

- * 1U Housing including
 - hot plug Power supply unit with one 770W PSU module and power cord rack 4m length (can be upgraded with one additional PSU module)
- * Fans
- Redundant and hot plug system fans (6x)
- * Drives / Bays
 - 6x 2.5" SAS / SATA HDD option or 8x 2.5" SAS / SATA HDD option
 - (Four bays are supported with the onboard SATA controller or with the 1064 modular RAID controller 6 or 8 bays are supported with the 1068 and 1078 modular RAID controllers.)
 - 1 bay SATA DVD-ROM 0,5" height (option)
- * Integrated ServerView Diagnostics Technology for indication of internal failed components

Options:

- * 2nd hot plug power supply module 750W (PSU) for redundancy
- * Two optional Rackmount kits

RMK-F1_RX100-200-300 (full extraction) or

RMK-ST_RX100-200 (partial extraction with lower cost)

- * 6x 2.5" HD backplane kit with additional DVD option
- * 8x 2.5" HD backplane kit (no DVD possible)
- Optional modular RAID 0/1/1e controller with IME (Integrated Mirroring Enhanced) support based on LSI 1064 / 1068 chipset or as alternative
- optional modular RAID 5 controller based on LSI 1078 chipset
- * LED's in the front panel for indication of a failed CSS component (Customer Self Service) Simultaneously components are marked which can be replaced by the customer.

This LEDs can be dispalyed during service even without mains connection.

Systemboard D2786 with:

- * Up to two Xeon Dual Core, Quad-Core or Turbo Quad Core CPU's (Nehalem-EP, LGA 1366 socket) with serial QPI links (Quick Path Interconnect) and three memory channels per CPU First CPU has to be selected for an orderable basic unit.
- * Chipset Intel® 5500 (codenamed Tylersburg-24D = Tylersburg-EN)
- * ICH10R Southbridge with onboard SATA-RAID 0/1 support
- 3 PCle slots
 - -1x PCIe-2 x8 (standard and Low Profile cards) and 1x PCIe-2 x8 (Low Profile cards only)
 - -1x PCIe-2 x4 internal for modular RAID controller only
- * 12 memory slots for max. 96GB with 8GB registered DDR3 RAM or

max. 24GB with 2GB unbuffered DDR3 RAM available

- Memory is divided into 6 DIMMs per CPU (3 channels with 2 slots per channel)
- Max. two registered modules or two unbuffered modules are possible per channel
- No mix of registered and unbuffered modules is allowed
- First Memory (one module) has to be selected for an orderable basic unit per CPU
- Memory upgrade is possible module wise for the Independent Channel Mode or for the Performance Mode,
- Mirrored Channel Mode is supported with 2 identical modules in channel A+B CPU 1 or D+E CPU 2
- Spare Channel Mode is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2 (Spare Channel Mode as soon as released)
- SDDC (Chipkill) is supported only for registered memory modules,
- * 4-port SATA controller on-board included in Intel Southbridge ICH10R for SATA Raid0/1, Max. 4 SATA HD`s are supported
- * One SATA port on-board for 1x DVD integrated in the Intel Southbridge ICH10R
- * Dual Port 10/100/1000 x4 PCI Express* Gigabit Ethernet Intel LAN controller 82575EB (Zoar) on-board
- * iRMC S2 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100 Service LAN-port and integrated graphics controller.

The Service LAN-port can be switched alternatively on standard Gbit LAN port 1

* Graphics Controller integrated in iRMC S2 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz

(1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

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Interfaces at the rear:

- * 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- * 1x VGA (15 pins): If Front-VGA is used, then Rear-VGA is disabled
- * 3x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- * 2x LAN RJ45, 1x Service-LAN RJ45

Interfaces on the front:

- * 3x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- * 1x VGA (15 pins): If Front-VGA is used, then Rear-VGA is disabled

Interfaces internal:

- * 1x USB 2.0 (UHCI) with 480MBit/s for dongle funcionality (uSSD memory), no USB wakeup
- * 1x SATA interface for DVD (only usable with 6x 2.5" HDD + DVD Option)
- 4x SATA interface for 4 SATA HD`s (only usable with 6x 2.5" HDD + DVD Option)

Cables

- One SAS cable for up to 4 internal hot plug HDDs if the the 6x 2.5" HDD + DVD Option is configured Second SAS cable is optional for port 5 and 6 if max 6 HD's are required
- 2. Two SAS cables for up to 8 internal hot plug HDDs if the 8x 2.5" HDD Option is configured
- 3. Power cable

Software:

- ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
- Documentation engl. (multilingual on CD)



Mounting kits for PRIMERGY RX200 S5

- 1 pair of telescopic rails either full or partial extraction
- with partial extraction server can not be fully pulled out, but lower cost version of RMK
- 1 Vario carrier DC-PC-3rd party Rack
- allows toolless adjustable in depth and easy mounting

Mounting kit for mounting of servers in FSC 19" PRIMECENTER- racks and all server racks conforming to EIA standard EIA-310-D for 19" racks.

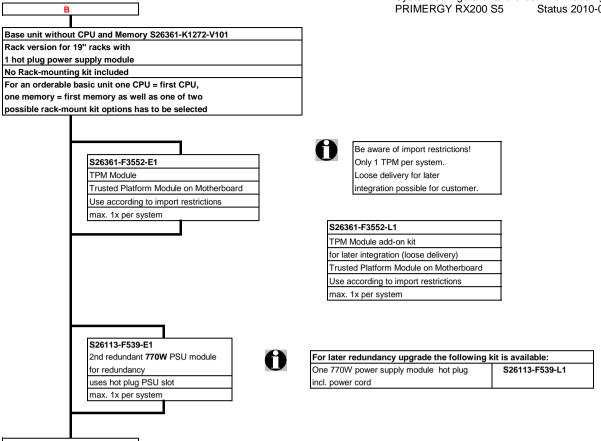
Therefore the mounting kit is variable in depth from 704-790mm

Cables included in basic unit

Connections		Cable	PRI	MERGY RX200 S5	K	ey:
1. SATA DVD	0		0	(optional)	(a) (c)	SAS SATA
2. 4-port SAS cable HDDs	0		0			
3. 4-port SAS cable HDDs	0		0	(optional)		
4. Power cable						

Conditions for SATA cable and one ore two 4-port SAS cables see description "Cables" above

В



D

Section

Processor



There are 2 processor LGA1366 sockets available.

The first socket is always equipped with the first CPU

It is also possible to upgrade a dual-processor system later on with a second CPU

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU

One DIMM per channel = max. 1333MHz, two DIMMs per channel = max. 1066MHz,

with two quad rank DIMMs or each mix with quad rank DIMMs per channel = 800MHz

The memory channel with the lowest speed defines the speed of all CPU channels in the system,

also for the channels of the second CPU if configured.

A multi-processor operating system is required for a dual-processor system.

Max. two CPU's can be selected per basic unit	
One of following CPU's has to be selected as first CPU	
for an orderable basic unit	
Optional second CPU has to be the same type like the first CPU	
Dual-Core CPU with max. 800MHz DDR3 speed (4.8GT/s)	
- 1x 64-bit Intel Xeon DP (4MB shared TLC = Third Level Cache)	
with passive heat sink, occupies socket for one CPU	
Xeon DP E5502 (1,86GHz/4M/4,8GT) / 80W	S26361-F3286-E186
Quad-Core CPU's with max. 800MHz DDR3 speed (4.8GT/s)	
- 1x 64-bit Intel Xeon DP (4MB shared TLC = Third Level Cache)	
and passive heat sink	
occupies socket for one CPU	
Xeon DP E5504 (2.00GHz/4M/4,8GT) / 80W	S26361-F3287-E200
Xeon DP E5506 (2.13GHz/4M/4,8GT) / 80W	S26361-F3287-E213
Turbo Quad-Core CPU's with max. 1066MHz DDR3 speed (5.86GT/	/s)
 1x 64-bit Intel Xeon DP (8MB shared TLC = Third Level Cache); Hype 	er-Threading (HT)
and passive heat sink	
occupies socket for one CPU	
Xeon DP E5520 (2.26GHz/8M/5,86GT) / 80W	S26361-F3288-E226
Xeon DP E5530 (2.40GHz/8M/5,86GT) / 80W	S26361-F3288-E240
Xeon DP E5540 (2.53GHz/8M/5,86GT) / 80W	S26361-F3288-E253
Turbo Quad-Core CPU's with max. 1333MHz DDR3 speed (6.4GT/s	5)
 1x 64-bit Intel Xeon DP (8MB shared TLC = Third Level Cache); Hype 	er-Threading (HT)
and passive heat sink	
occupies socket for one CPU	
Xeon DP X5550 (2.66GHz/8M/6,4GT) / 95W	S26361-F3289-E266
Xeon DP X5560 (2.80GHz/8M/6,4GT) / 95W	S26361-F3289-E280
Xeon DP X5570 (2.93GHz/8M/6,4GT) / 95W	S26361-F3289-E293
Low Voltage Quad-Core CPU with max. 800MHz DDR3 speed (4.80	GT/s)
- 1x 64-bit Intel Xeon DP (4MB shared TLC = Third Level Cache)	
with passive heat sink	
occupies socket for one CPU	
Xeon LV DP L5506 (2,13GHz/4M/4,8GT) / 60W	S26361-F3290-E213
Low Voltage Turbo Quad-Core CPU with max. 1066MHz DDR3 spec	ed (5.86GT/s)
 1x 64-bit Intel Xeon DP (8MB shared TLC = Third Level Cache); Hype 	er-Threading (HT)
and passive heat sink	
occupies socket for one CPU	
Xeon LV DP L5520 (2,26GHz/8M/5,86GT) / 60W	S26361-F3290-E226
Xeon LV DP L5530 (2,40GHz/8M/5,86GT) / 60W	S26361-F3290-E240

Note: Max. DDR3 Bus Speed depends on:

- max. DDR3 Bus Speed from the CPU and
- max. DDR3 Memory Speed and
- max. memory modules on one memory channel

E

Section

Memory



- There are 6 memory slots for max. 48GB registered (reg) DDR3 RAM per CPU available with 8GB RDIMMs or max. 12GB unbuffered (ub) DDR3 RAM per CPU available with 2GB UDIMMs => max. 96GB registered or 24GB unbuffered RAM for two CPU's possible

(For explanation of following terms refer to section "Memory Configurations"

- The memory area is divided into 3 channels per CPU with 2 slots per channel
- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2

Registered and unbuffered memory modules can be selected

No mix of registered and unbuffered modules allowed.

DDR3 1066 and 1333MHz modules can be mixed, but run always with the slower speed.

With two DIMMs per channel only 1066MHz is possible independent of the module speed.

SDDC (Chipkill) is supported only for registered memory modules.

1.) In the "Independent Channel Mode" is following configuration possible

Each slot can optionally be equipped either with registered x4 organized DDR3 modules:
 2GB single rank, 4GB and 8GB dual rank,

or with unbuffered x8 organized DDR3 modules: 1GB single rank and 2GB dual rank

2.) In the "Spare Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 3x2GB single rank,

3x4GB and 3x8GB dual rank DDR3 modules.

Each slot of one bank has to be equipped with identical modules for spare channel mode

In channel A and B of CPU 1 or channel D and E of CPU 2 are always the active memory modules,

in channel C of CPU 1 and channel F of CPU 2 is always the spare module

No special order codes with UDIMMs are offered for this mode

3.) In the "Mirrored Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 2x2GB single rank,

2x4GB and 2x8GB dual rank DDR3 modules.

In each memory bank channel A and B of CPU 1 or channel D and E of CPU 2 have to be equipped with identical modules for mirrored channel mode. Channel C of CPU 1 and channel F of CPU 2 is not equipped

In channel B is always the mirrored memory of channel A of CPU 1

In channel E is always the mirrored memory of channel D of CPU 2

No special order codes with UDIMMs are offered for this mode

- For each CPU minimum 1 memory module has to be configured in Independent Channel Mode

(=> Additional memory extensions can still be configured up to five times per CPU) or

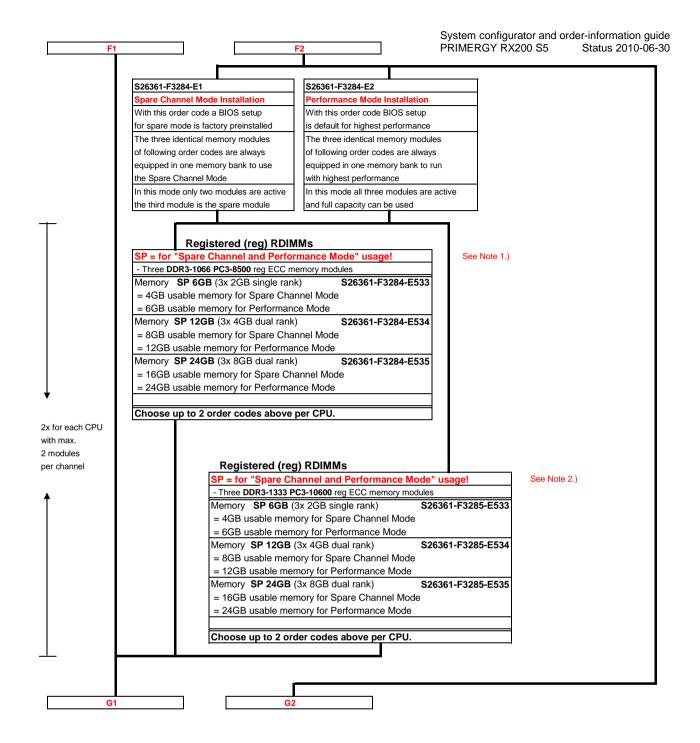
one bank has to be equipped with two modules (channel A+B for CPU 1 or D+E for CPU 2) in Mirrored Channel Mode

(=> Additional memory extensions can still be configured up to one time per CPU) or

one bank has to be equipped with three modules (channel A+B+C for CPU 1 or D+E+F for CPU 2) In Spare Channel Mode or Performance Mode

(=> Additional memory extensions can still be configured up to one time per CPU)

F



Memory Configuration PRIMERGY RX200 S5

Each CPU offers 6 Slots for DDR3 Memory Modules organised in 2 Banks and 3 Channels.

If you need more than 6 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 2 different kinds of DDR3 Memory Modules available: UDIMM and RDIMM. UDIMM and RDIMM offer different functionality.

Mode	Configuration	UDIMM	RDIMM	Application
chip kill support	any	n.a.	yes	detect multi-bit errors
Independant Channel Mode	1, 2 or 3 Modules per Bank	Х	Х	offers max. flexibility, upgradeability, capacity
				use UDIMM modules for lowest cost
Mirrored Channel Mode	2 identical Modules / Bank	**)	Х	offers maximum security
Performance Mode *)	3 identical Modules / Bank	**)	Х	offers maximum performance and capacity
Spare Channel Mode *)	3 identical Modules / Bank	**)	Х	balances security and capacity

^{*) =} Performance Mode and Spare Channel Mode use different BIOS settings. (Spare Channel Mode as soon as released)

x = order codes available

Capacity	Configuration	UDIMM	RDIMM	Notes
Min. Memory per CPU	1 Module / CPU	1GB	2GB	with one CPU
Max. Memory per CPU	6 Modules / CPU	12GB	48GB	with one CPU
Max. Memory per System	12 Modules / System	24GB	96GB	if second CPU is configured

Memory-Speed:

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU

One DIMM per channel = max. 1333MHz, two DIMMs per channel = max. 1066MHz, three DIMMs per channel = max. 800MHz, The memory channel with the lowest speed defines the speed of all CPU channels in the system,

Used CPU	ed CPU Max. Memory-Bus speed depending on DIMMs / channel if following memory speed is used for specific CPU's					
	1066MHz	1066MHz	1066MHz	1333MHz	1333MHz	1333MHz
	(1DIMM)	(2 DIMMs)	(3 DIMMs)	(1 DIMM)	(2 DIMMs)	(3 DIMMs)
Dual-Core CPU						
with max. 800MHz DDR3 speed (4.8GT/s)						
Xeon DP E5502 (1,86GHz/4M/4,8GT) / 80W	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz
Quad-Core CPU's						
with max. 800MHz DDR3 speed (4.8GT/s)						
Xeon DP E5504 (2.00GHz/4M/4,8GT) / 80W	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz
Xeon DP E5506 (2.13GHz/4M/4,8GT) / 80W	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz
Turbo Quad-Core CPU`s						
with max. 1066MHz DDR3 speed (5.86GT/s)						
Xeon DP E5520 (2.26GHz/8M/5,86GT) / 80W	1066 MHz	1066 MHz	800 MHz	1066 MHz	1066 MHz	800 MHz
Xeon DP E5540 (2.53GHz/8M/5,86GT) / 80W	1066 MHz	1066 MHz	800 MHz	1066 MHz	1066 MHz	800 MHz
Turbo Quad-Core CPU`s						
with max. 1333MHz DDR3 speed (6.4GT/s)						
Xeon DP X5550 (2.66GHz/8M/6,4GT) / 95W	1066 MHz	1066 MHz	800 MHz	1333 MHz	1066 MHz	800 MHz
Xeon DP X5570 (2.93GHz/8M/6,4GT) / 95W	1066 MHz	1066 MHz	800 MHz	1333 MHz	1066 MHz	800 MHz
Low Voltage Quad-Core CPU						
with max. 800MHz DDR3 speed (4.8GT/s)						
Xeon LV DP L5506 (2,13GHz/4M/4,8GT) / 60W	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz	800 MHz
Low Voltage Turbo Quad-Core CPU						
with max. 1066MHz DDR3 speed (5.86GT/s)						
Xeon LV DP L5520 (2,26GHz/8M/5,86GT) / 60W	1066 MHz	1066 MHz	800 MHz	1066 MHz	1066 MHz	800 MHz

Configuration hints:

- The memory sockets on the systemboard offer a color coding:

Bank I black sockets

Bank II blue sockets (or white latch)

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)

Bank I on CPU 1

Bank II on CPU 1

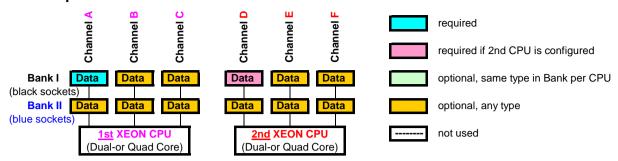
Bank I on CPU 2

Bank II on CPU 2

- See below (next page) for a detailed descriptions of the memory configuration supported.

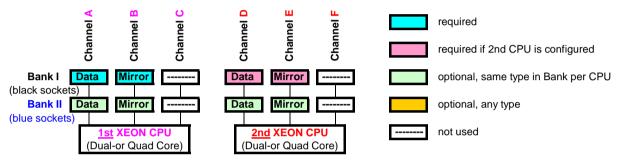
^{**) =} technically possible but no Order Numbers available, use at your own risk

1. Independent Channel Mode



Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system Independent Channel Mode is supported using UDIMM or RDIMM memory modules

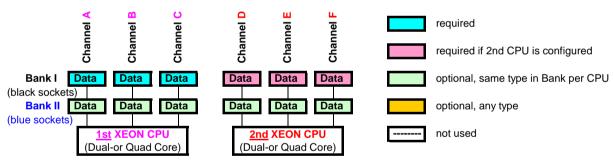
2. Mirrored Channel Mode



Mirrored Channel Mode requires identical modules on channel A and B (1st CPU) or channel D and E (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory channel C (1st CPU) or channel F (2nd CPU) are not usable in Mirrored Channel Mode

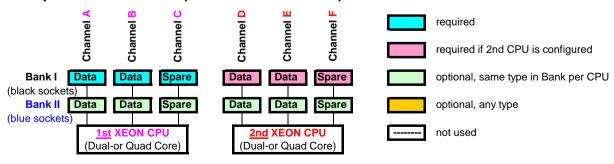
Mirrored Channel Mode is supported using RDIMM memory modules

3. Performance Channel Mode

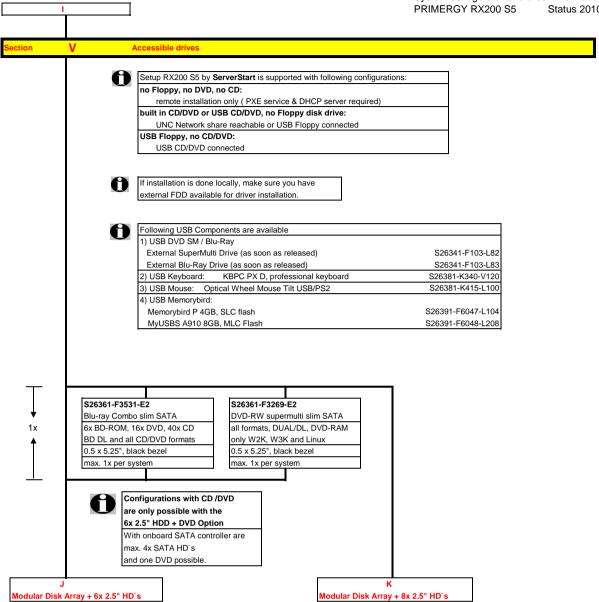


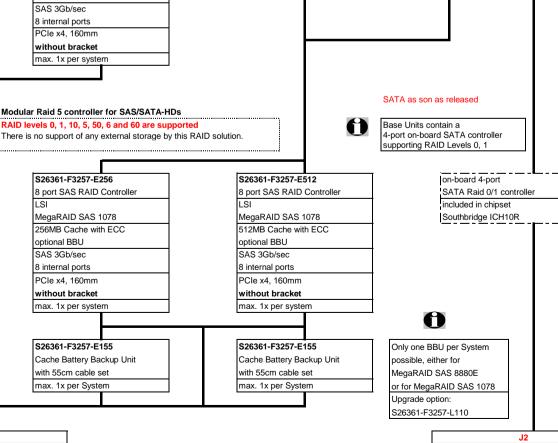
Performance Channel Mode requires identical modules on all channels of each Bank per CPU Performance Channel Mode is supported using RDIMM memory modules

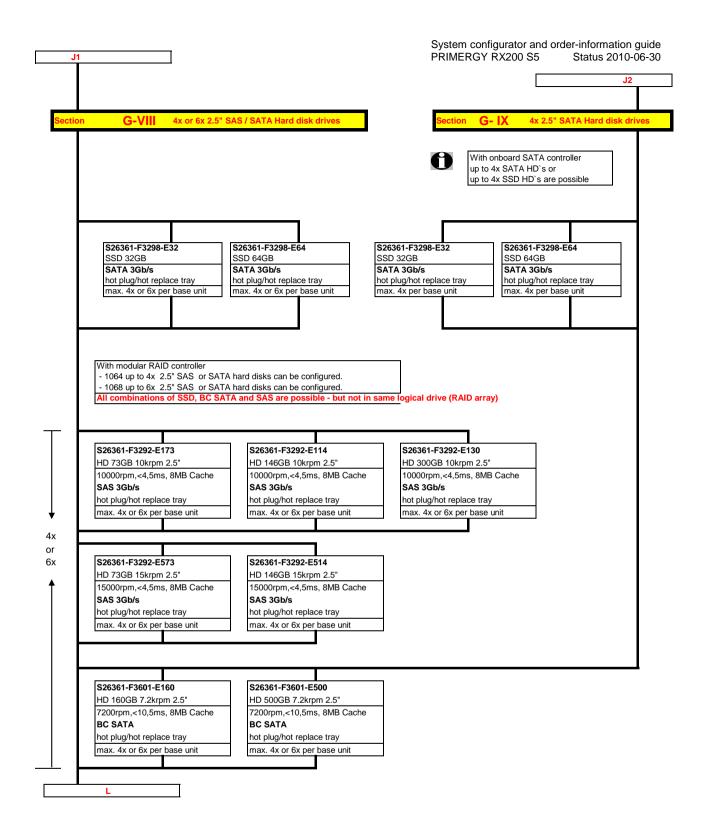
4. Spare Channel Mode (As soon as released)

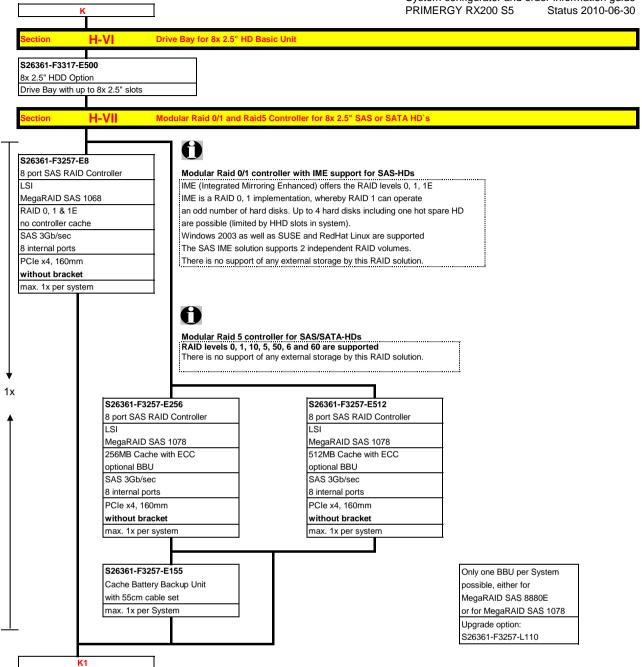


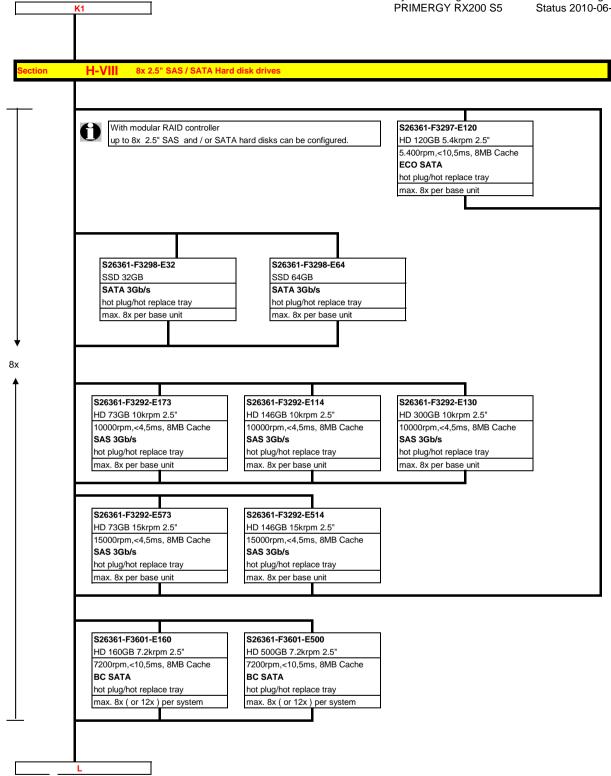
Spare Channel Mode requires identical modules on all channels of each Bank per CPU one third of the capacity is used for the spare => the available memory for applications is two thirds of the installed memory Spare Channel Mode is supported using RDIMM memory modules

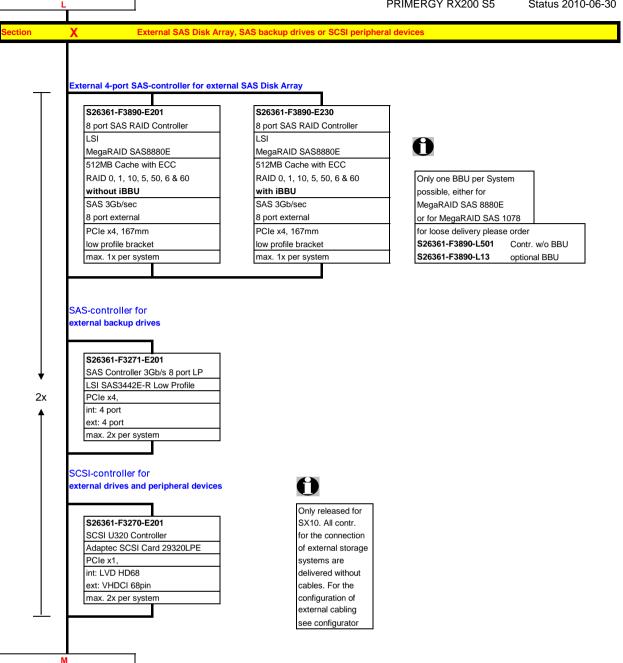


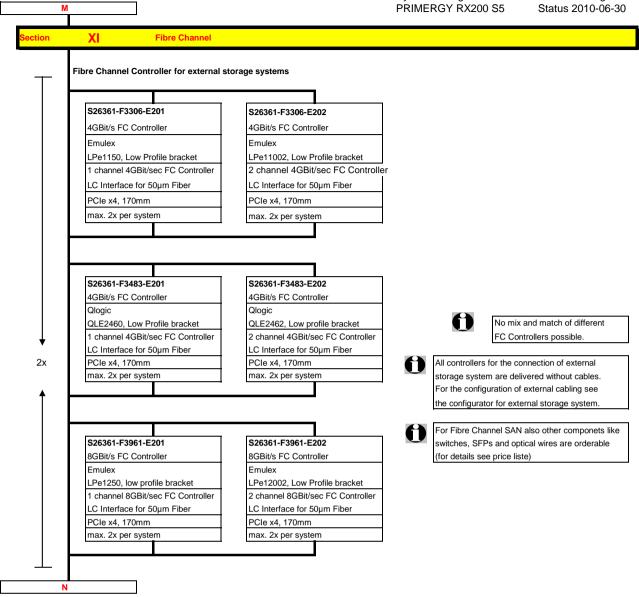












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End PRIMERGY RX200 S5

Change Report

Date	Order number	Changes
2010-04-06	S26361-F3601-E160/500	new BC-SATA HD drives - now available
2009-10-01	S26361-F3299-E32/64	new SSD HD drives - as soon as available
2009-06-30	S26361-F3284-E1	Spare Channel Mode Installation - now available
2009-06-17		Added E5530 and X5560 CPU
2009-03-31		First Release